Rocktech Displays Limited



Module P/N·	RK101HU01-T
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Version: 2.0

Description: 10.1 inch TFT 1024*600 Pixels

With LED backlight, LVDS interface

All viewing angle and Resistive touch panel

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Revision History

Date	Rev.	Page	Description
2017-09-26	1.0	All	First issue
2018-05-24	2.0	6	Modify electrical specification



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1. General Features

Item	Spec	Remark
Display Mode	Normally Black transmissive	
Viewing Direction	Free	
Input Signals	LVDS	
Outside Dimensions	235(W) x143.0(H) x4.48(D)	With TP
Active Area	222.72mm(W)×125.28mm(H)	
Number of Pixels	1024(RGB)×600	
Dot Pitch	0.2175(H) × 0.2088mm(W)	



2. Absolute Maximum Ratings

The following are maximum values which, if exceeded may cause operation or damage to the unit.

ITEM	Sym.	Min.	Max.	Unit	Remark
Power Supply Voltage	Vcc	-0.3	5.0	V	GND=0
Logic Signal Input Level	Vinput	-0.3	Vcc+0.3	V	
Operation Temperature	Тор	-20	70	$^{\circ}$	
Storage Temperature	Tst	-30	80	$^{\circ}$	



3. Electrical Specification

3.1 Driving TFT LCD Panel

ITEM	Sym.	Min.	Тур.	Max.	Unit	Remark
	Vcc	3.0	3.3	3.6	V	
	VGH	19.4	20.0	20.6	V	
Supply Voltage	VGL	-10.3	-10.0	-9.7	V	
	Avdd	8.7	9.0	9.3	V	
	Vcom	4.11	4.41	4.71	V	
Input Signal Valtage	VIH	0.7Vcc	-	Vcc	V	
Input Signal Voltage	VIL	0	-	0.3Vcc	V	

3.2 Driving Backlight

Item	Sym.	Min	Тур.	Max	Unit	Note
Backlight driving voltage	VF	1	9.6	1	V	
Backlight driving current	lF	-	280	-	mA	
Backlight Power Consumption	WBL	-	2688	1	mW	
Life Time	1	-	30,000	-		Note 3

Note 1: (Unless specified, the ambient temperature $Ta=25^{\circ}$)

Note 2: The recommended operating conditions refer to a range in which operation of this product is guaranteed. Should this range is exceeded, the operation cannot be guaranteed even if the values may be without the absolute maximum ratings.

Note 3: If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



4.Optical Specifications

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25 $^{\circ}$ C. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle of Φ and θ equal to 0° .

Maria	Curre		Values			Note	
ltem	Sym.	Min.	Тур.	Max.	Unit	Note	
1)Contrast Ratio	C/R	600	800	-		FIG.1	
2)Module Luminance	L	-	280	-	cd/m ²	After TP	
3)Response time	Tr+Tf	-	30	-	Ms	FIG.2	
	θ_{T}	-	85	-			
4)\/inving.Angle	θ_{B}	-	85	-	Deame	FIG 2	
4)Viewing Angle	θ_{L}	-	85	-	Degree	FIG.3	
	θ_{R}	-	85	-			
	Wx	0.259	0.309	0.359			
	Wy	0.297	0.347	0.397			
	Rx	-	-	-			
5) Characasticita	Ry	-	-	-			
5)Chromaticity	Gx	-	-	-			
	Gy	-	-	-			
	Вх	-	-	-			
	Ву	-	-	-			



♦ Measurement System

Notes:

1. Contrast Ratio(CR) is defined mathematically as :

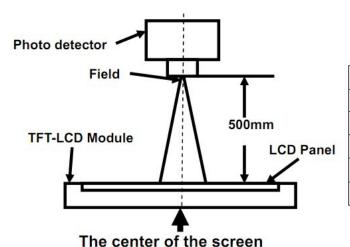
Surface Luminance with all white pixels

Contrast Ratio = ------

Surface Luminance with all black pixels

- 2. Surface luminance is the center point across the LCD surface 500mm from the surface with all pixels displaying white. For more information see FIG 1.
- 3. Response time is the time required for the display to transition from white to black (Rising Time, Tr) and from black to white (Falling Time, Tf). For additional information see FIG 2.
- 4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

FIG. 1 Optical Characteristic Measurement Equipment and Method



Item	Photo detector	Field
Contrast Ratio		
Luminance	CD 24	1°
Chromaticity	SR-3A	1
Lum Uniformity		
Response Time	BM-7A	2°



FIG. 2 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

Response Time = Rising Time(Tr) + Falling Time(Tf)

- Rising Time(Tr): Full White 90% → Full White 10% Transmittance.
- Falling Time(Tf): Full White 10% → Full White 90% Transmittance.

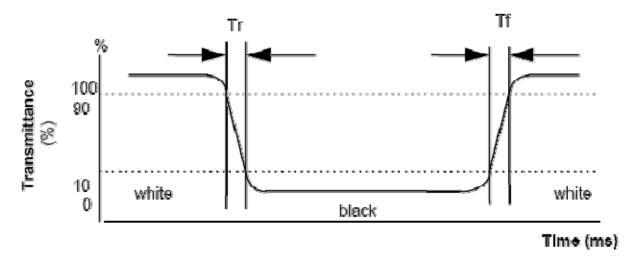
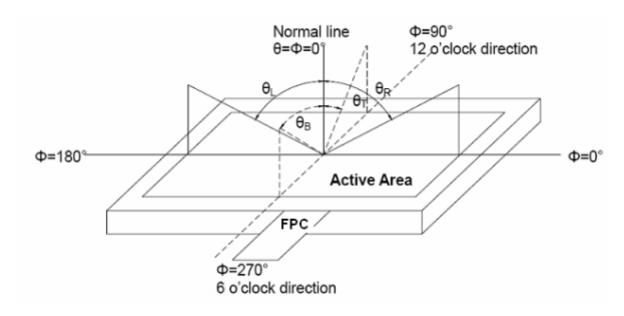


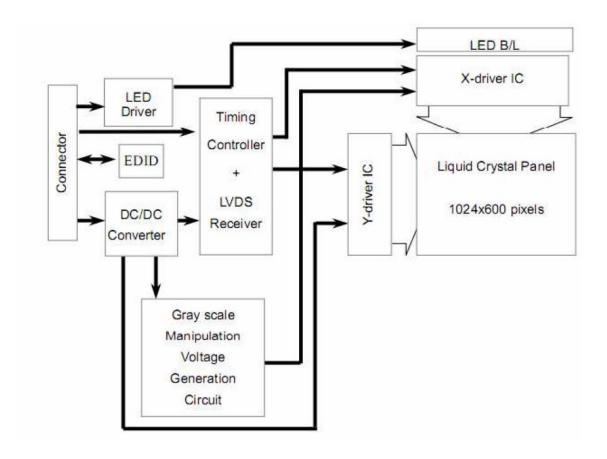
FIG. 3 The definition of Viewing Angle

Use Fig. 1(Test Procedure) under Measurement System to measure the contrast from the measuring direction specified by the conditions as the following figure.





5. Block Diagram





6. Pin Description 6.1 TFT PIN Interface

PIN NO	SYMBOL	Description
1	VCOM	Comon Voltage
2	VDD	Power Voltage for digital circuit
3	VDD	Power Voltage for digital circuit
4	NC	No connection
5	RESET	Global reset pin. Active low to enter reset
		state. Suggest to connecting with an RC reset
		circuit for stability. Normal pull high.(R=10K
		ohm, C=0. 1uF)
		Note:If RC is not added, users must follow the
		rule, T2>50ms to keep low power.
6	STBYB	Standby mode, Normal pulled high
		STBYB=1, normal operation;
		STBYB=0, timing controller, source driver will turn
		off,all output are High-Z.
7	GND	Ground
8	RXINO-	-LVDS differential data input
9	RXIN0+	+LVDS differential data input
10	GND	Ground
11	RXIN1-	-LVDS differential data input
12	RXIN1+	+LVDS differential data input
13	GND	Ground
14	RXIN2-	-LVDS differential data input
15	RXIN2+	+LVDS differential data input
16	GND	Ground
17	RXCLKI	-LVDS differential clock input
	N-	
18	RXCLKI	+LVDS differential clock input
	N+	
19	GND	Ground
20	RXIN3-	-LVDS differential data input
21	RXIN3+	+LVDS differential data input
22	GND	Ground
23	NC	No connection



24	NC	No connection	
25	GND	Ground	
26	NC	No connection	
27	NC	No connection	
28	SELB	6bit/8bit mode select(Note 1)	
29	AVDD	Power for Analog Circuit	
30	GND	Ground	
31	LED-	LED Cathode	
32	LED-	LED Cathode	
33	L/R	Horizontal inversion(Note 2)	
34	U/D	Vertical inversion(Note 2)	
35	VGL	Gate OFF Voltage	
36	NC	No connection	
37	NC	No connection	
38	VGH	Gate ON Voltage	
39	LED+	LED Anode	
40	LED+	LED Anode	

I:input 0:Output P:Power

Note1:If LVDS input data is 6 bits, SELB must set to High;

If LVDS input data is 8 bits, SELB must set to Low.

Note2: When L/R=0, set right to left scan direction.

When L/R=1, set left to right scan direction.

When U/D=0, set top to bottom scan direction.

When U/D=1, set bottom to top scan direction.

6.2 RTP PIN Interface

Pin	Symbol	Description
1	YU(Y+)	TP pin up side
2	XL(X-)	TP pin left side
3	YD(Y-)	TP pin down side
4	XR(X+)	TP pin right side

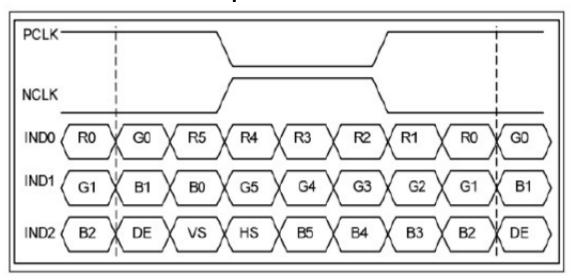


7. Timing Characteristics

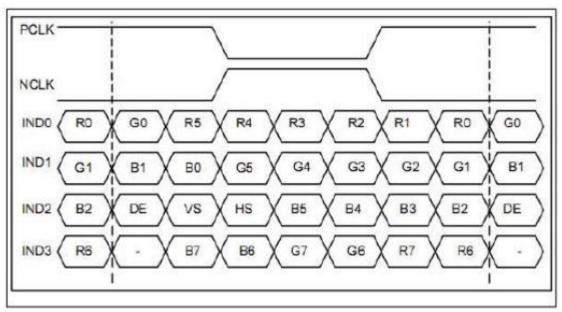
7.1 Switching Characteristics for LVDS Receiver

Item	Symbol	Mψ.	Тур.	Max.	Unit	Conditions
Differential Input High Threshold	Vth	_		100	mV	V
Differential Input Low Threshold	VtI	-100	10-10	2_2	mV	V _{CM} =1.2V
Input Current	I _{IN}	-טר	2-2	+10	uA	
Differential input Voltage	[V _{ID}]	0.1		0.6	V	
Common Mode Voltage Offset	V _{CM}	0.7	1.2	1.6	٧	

7.2 Bit LVDS input 7.2.1 6 bit LVDS input



7.2.2 8 bit LVDS input

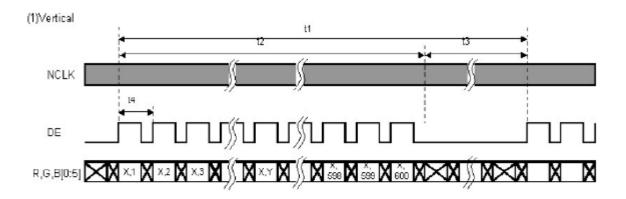


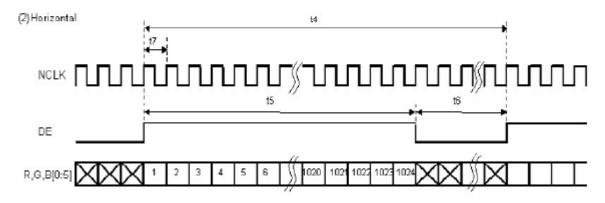


7.3 Interface Timing (DE mode)

Item	Symbol	Min.	Тур.	Max.	Unit
Frame Rate	()	55	60	65	Hz
Frame Period	t1	612	635	680	line
Vertical Display Time	t2	600	600	600	line
Vertical Blanking Time	t3	12	35	80	line
1 Line Scanning Time	t4	1114	1344	1400	clock
Horizontal Display Time	t5	1024	1024	1024	clock
Horizontal Blanking Time	t6	90	320	376	clock
Clock Rate	t7	40.8	51.2	61.6	MHz

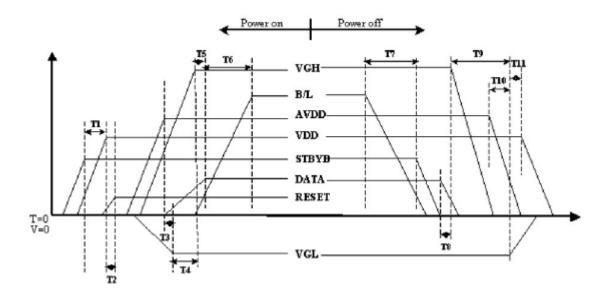
Timing Diagram of Interface Signal (DE mode)







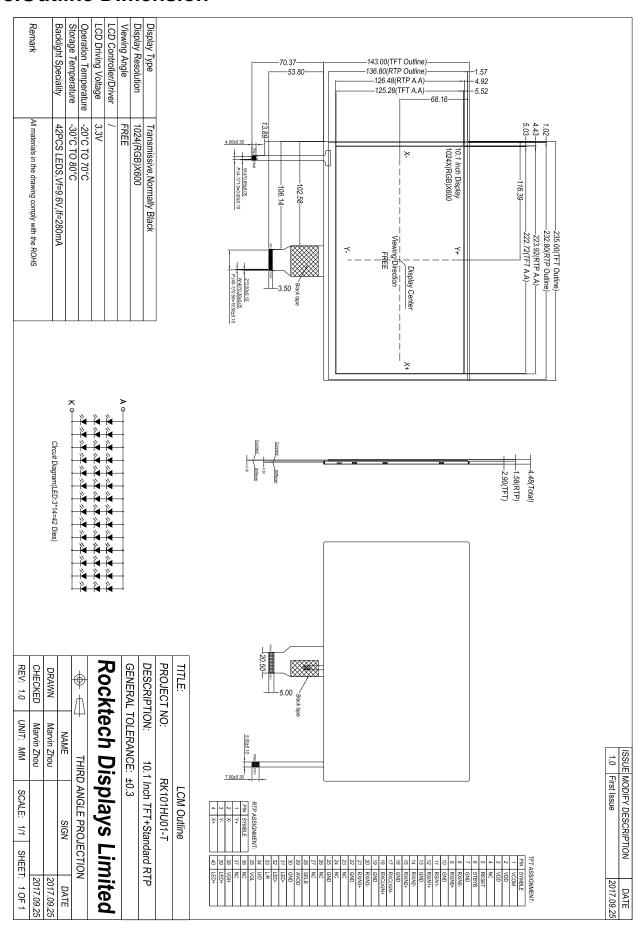
7.4 Power on/off Sequence



Item	Min	Тур	Max	Unit
T1	0	1	-	ms
T2	50	1	-	ms
T3	5	-		ms
T4	10	-	1	ms
T5	20	-		ms
T6	50	-		ms
T7	20	-	:	ms
T8	10			ms
T9	20	-		ms
T10	10			ms
T11	20			ms



8.Outline Dimension





9. Reliability and Inspection Standard

No.	Test Item		Test Conditions	Remark		
1	High Temperature	Storage	80℃, 120Hr	Note		
		Operation	70 ℃, 120 Hr	Note		
2 Low Temperatu	Low Tomporatura	Storage	-30℃, 120Hr	Note		
	Low remperature	Operation	-20℃, 120Hr			
3	High Temperature and High Humidity		40℃, 90%RH, 120Hr	Note		
4	Peeling Off (Storage)		≥500gf/cm	Note		
5	FPC Bending Test		FPC Bending Test ≥6,000 times, 2/sec			
6	Vibration Test(Storage)		Vibration Test(Storage) 50HZ, 30min, Amplitude: 2 cm, X/Y/Z direction		50HZ, 30min, Amplitude: 2 cm, X/Y/Z directions	Note
7	Drop Test		60cm/ 3Corner/ 8Face, 1Cycle	Note		

Note:

- 1) The test samples should be applied to only one test item.
- 2) Sample size for each test item is 5~10pcs.
- 3) For Damp Proof Test, pure water(Resistance>1M Ω) should be used.
- 4) In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5) EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and fluorescence EL has.
- 6) After the reliability test, the test samples should be inspected after 2 hours at least.
- 7) Functional test is OK. Missing segment, shorts, unclear segment, non display, display abnormally, liquid crystal leak are not allowed.
- 8) After testing, the current Idd should be within initial value ±20%.
- 9) No low temperature bubbles ,end seal loose and fall, frame rainbow, ACF bubble growing are allowable in the appearance test.



10.PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
 - Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.
- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal



connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.